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## TRANSPARENT INTER-METAL DIELECTRIC STACK FOR CMOS IMAGE SENSORS

Leah Markowitz Roey Shaviv

## ABSTRACT

A transparent inter-metal dielectric utilized in a CMOS image sensor includes a flowlayer sandwiched between a base  $SiO_2$  layer and a cap  $SiO_2$  layer. The flowlayer is formed by reacting  $SiH_4$  and  $H_2O_2$  using a shortened  $H_2O_2$  stabilization time, using a reduced deposition pressure, and while maintaining the reaction chamber platen at a target value of approximately 1°C.